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Reference Applications Framework Working Group	Daniel Orsatti, STMicroelectronics	Open	
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15693 VCD Mode Task Force	Daniel Orsatti, STMicroelectronics	Open	T5T: Erich Reisenhofer, NXP
Tags and Formats Task Force	Klaus Roehrle, Sony	Daniel Orsatti, STMicroelectronics	T1T: Open T2T: Henk Dannenberg, NXP T3T: Klaus Roehrle, Sony T4T: Henk Dannenberg, NXP

NFC Forum Chairs
as of March 2017

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Interoperability & Certification Tracks Task Force	Mick Conley, UL		
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